

The V525 is a single-width, C-size, VXIbus module that provides a prototyping and development platform consisting of a standard, VXI, register-based interface and an array of holes for circuit breadboarding.

APPLICATIONS

Product development and prototyping
Custom products

V525

VXIbus Development Module



An ideal platform to create a custom module

FEATURES

- Single-width VXI module
- VXI register-based interface
- Strap-selectable power and ground arrays
- Provisions for up to 3 plug-in development cards
- Front panel hardware, connectors, and shields are included

GENERAL DESCRIPTION

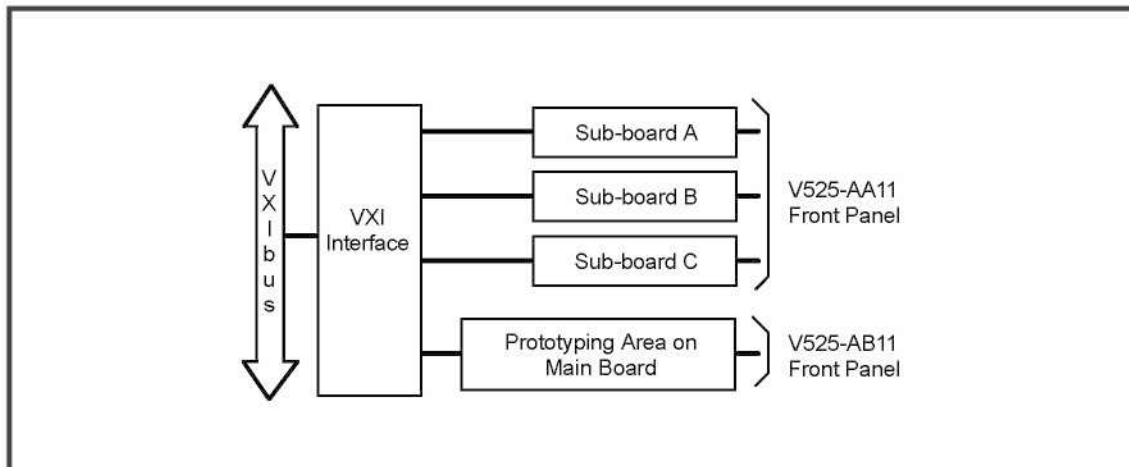
The V525 is a single-width, C-size, VXIbus module that provides a prototyping and development platform consisting of a standard, VXI, register-based interface and an array of holes for circuit breadboarding. Power and ground are strap-selectable to points within the array of holes that allow for IC packages with 0.3" and 0.6" pin spacing as well as spacing for PGA sockets up to 17 pins per side. In addition, six 50-position, interboard connectors are provided on the host module which carry VXIbus address, data, control, power, and ground signals. These connectors allow the user to develop circuitry on up to three plug-in submodule cards for reconfigurable or higher density applications.

The register-based VXI interface on the V525 provides the configuration registers required by the VXIbus specification so that the appropriate levels of system configuration can be accomplished. Access to the configuration registers is available through the VMEbus Short Address (A16) Space. The V525 supports both static and dynamic configuration. Additionally, circuitry is provided to interface to user-supplied operational registers positioned in VMEbus Standard Address (A24) Space.

The V525-AA11 option includes a front-panel that accepts three submodules with 68P High Density connectors. Sufficient interface and physical information is available to allow you to develop custom sub-modules. The V525-AB11 option includes a front panel and two 68P High Density board mounted connectors on the host module. LED indicators for address recognition and utility purposes as well as left and right-side ground shields are provided on both options.

Item	Specification
Interface Power Requirements +5V	1 A
Power Available to Breadboard/ Submodules +5 V -5.2 V -2 V + 12 V - 12 V + 24 V - 24 V + 15 V - 15 V	Note: Total available mainframe power must also be checked. 6 A max. 5 A max. 2 A max. 1 A max. 1 A max. 1 A max 1 A max TBD mA max. TBD mA max.
Environmental and Mechanical Temperature range Operational Storage Relative Humidity Cooling Requirements Dimensions Front-panel potential	0°C to 50°C -25°C to +75°C 0 to 85%, non-condensing to 40°C 10CFM 340 mm x 233.35 mm x 30.48 mm (V-size VXIbus) Chassis Ground

V525 Interface Paths





ORDERING INFORMATION

MODEL	DESCRIPTION
V525-AB11	VXIbus Development Module with host module connector front-panel option

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